

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

James M. Derderian

**Serial No.:** 10/770,890

Filed: February 2, 2004

For: METHODS FOR FORMING ASSEMBLIES AND PACKAGES THAT INCLUDE STACKED SEMICONDUCTOR DEVICES SEPARATED A DISTANCE DEFINED BY ADHESIVE MATERIAL INTERPOSED THEREBETWEEN

Confirmation No.: 1094

Examiner: L. Thai

Group Art Unit: 2891

Attorney Docket No.: 2269-4817.3US

(01-0103.03/US)

## CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

February 21, 2006

Date

Signature C Erika Gandre

Name (Type/Print)

## **AMENDMENT**

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This communication is being filed in response to the Office Action mailed on November 18, 2005, the three-month shortened statutory period for response to which expires on February 18, 2006.

Remarks begin on page 2 of this paper.